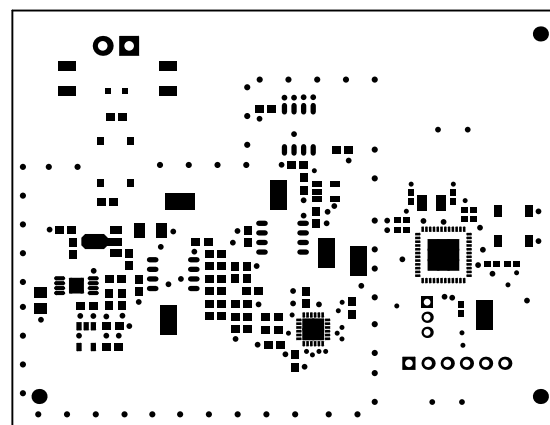
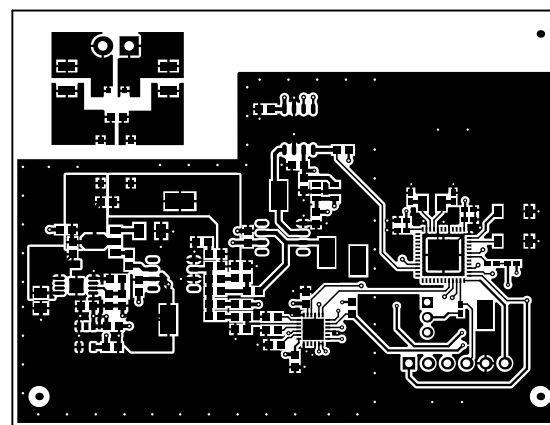


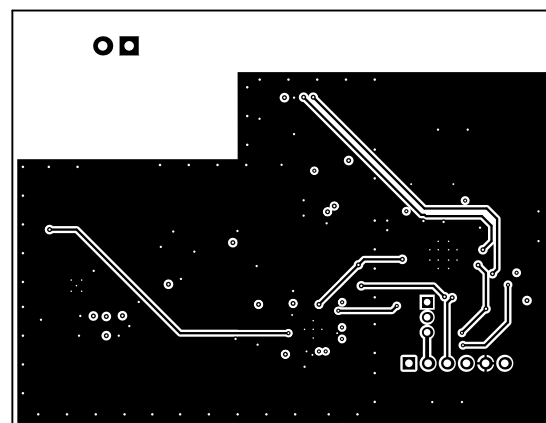
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01504	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay	TID #: N/A		
PLOT NAME = Top Overlay	GENERATED : 12/7/2017 11:21:19 AM	TEXAS INSTRUMENTS	



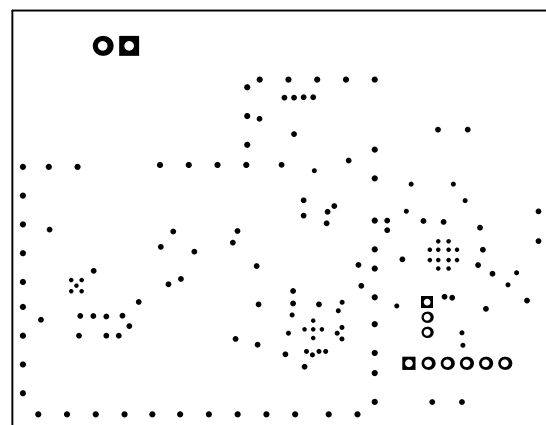
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01504	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Solder	TID #: N/A		
PLOT NAME = Top Solder Mask	GENERATED : 12/7/2017 11:21:20 AM	TEXAS INSTRUMENTS	



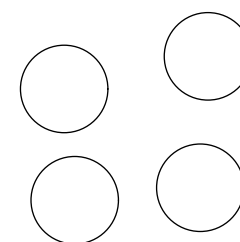
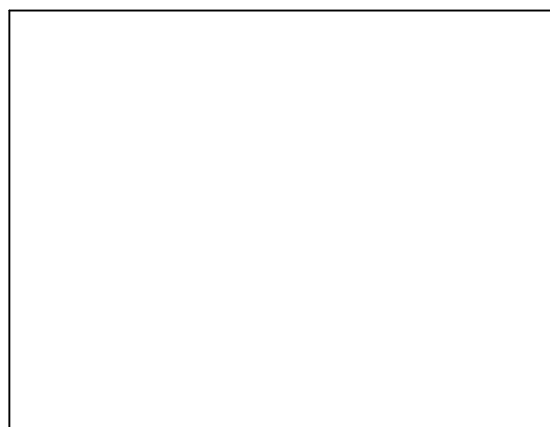
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01504	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Top Layer	TID #: N/A		
PLOT NAME = Top Layer	GENERATED : 12/7/2017 11:21:22 AM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01504	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Layer	TID #: N/A		
PLOT NAME = Bottom Layer	GENERATED : 12/7/2017 11:21:23 AM	TEXAS INSTRUMENTS	

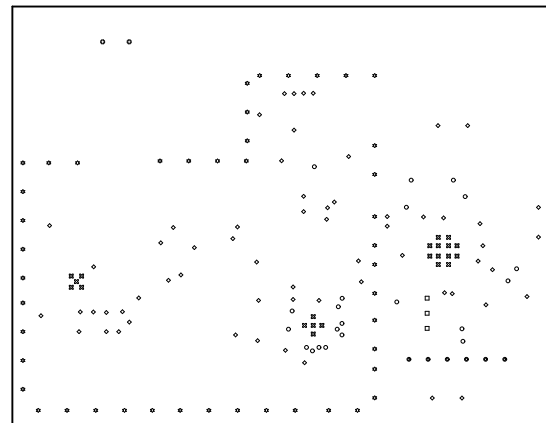


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01504	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder	TID #: N/A		
PLOT NAME = Bottom Solder Mask	GENERATED : 12/7/2017 11:21:25 AM	TEXAS INSTRUMENTS	

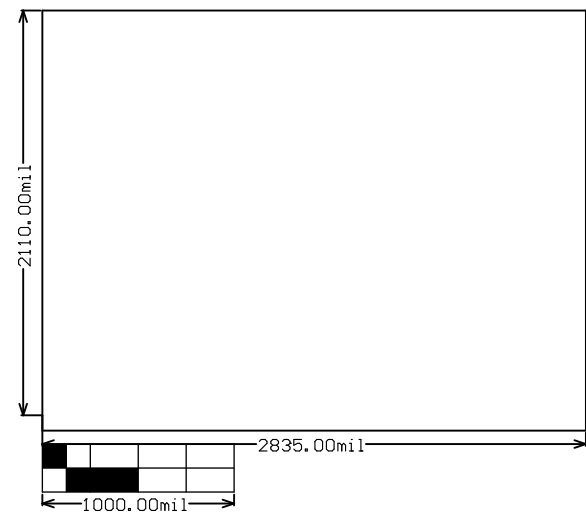


ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01504	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay	TID #: N/A		
PLOT NAME = Bottom Overlay	GENERATED : 12/7/2017 11:21:26 AM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type	Drill Layer Pair	Hole Tolerance
⊗	22	7.87mil (0.200mm)	PTH	Round	Top Layer - Bottom Layer	
○	21	10.00mil (0.254mm)	PTH	Round	Top Layer - Bottom Layer	
◇	62	12.00mil (0.305mm)	PTH	Round	Top Layer - Bottom Layer	
⊛	45	13.00mil (0.330mm)	PTH	Round	Top Layer - Bottom Layer	
□	3	35.00mil (0.889mm)	PTH	Round	Top Layer - Bottom Layer	
●	6	40.00mil (1.016mm)	PTH	Round	Top Layer - Bottom Layer	
⊕	2	50.00mil (1.270mm)	PTH	Round	Top Layer - Bottom Layer	
	161 Total					



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01504	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing	TID #: N/A		
PLOT NAME = Drill Drawing	GENERATED : 12/7/2017 11:21:27 AM		TEXAS INSTRUMENTS



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA01504	REV: E1	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions	TID #: N/A		
PLOT NAME = Board Dimensions	GENERATED : 12/7/2017 11:21:29 AM	TEXAS INSTRUMENTS	

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